

# **Express-HRR**

# Extreme Rugged™ COM Express® Type 6 Module with Intel® Core™ and Celeron® processor

### **Features**

- Quad/dual core Intel<sup>®</sup> Core<sup>™</sup> i7/i5/i3 and Celeron<sup>®</sup> Processors with Intel<sup>®</sup> QM67 Chipset
- Up to 16GB ECC 1333Mhz DDR3 memory in two SODIMM sockets
- Three Digital Display Interfaces (DDI) for HDMI/DVI/DisplayPort or SDVO
- Seven PCIe x1, one PCIe x16 (Gen2) for graphics (or general purpose x8/4/1)
- 2x SATA 6 Gb/s, 2x SATA 3 Gb/s, Gigabit Ethernet, 8x USB 2.0
- 50% Thicker PCB for high vibration environments
- Extreme Rugged operating temperature: -40°C to +85°C (build option)



### **Specifications**

### Core System

### CPU

Intel® Core™ i3/i5/i7, 32 nm process, BGA type
Intel® Core™ i7-2715QE 2.1 GHz (3.0 GHz Turbo), 6MB L3 cache, 45W
Intel® Core™ i7-2655LE 2.2 GHz (2.9 GHz Turbo), 4MB L3 cache, 25W
Intel® Core™ i7-2610UE 1.5 GHz (2.4 GHz Turbo), 4MB L3 cache, 17W
Intel® Core™ i5-2515E 2.5 GHz (3.1 GHz Turbo), 3MB L3 cache, 35W
Intel® Core™ i3-2340UE 1.3 GHz, 3MB L3 cache, 17W
Intel® Celeron® 847E 1.1 GHz, 2MB L3 cache, 17W
Intel® Celeron® 807UE 1.0 GHz, 1MB L3 cache, 10W

### Memory

Dual channel ECC 1333 MHz DDR3 memory up to 16 GB in dual SODIMM sockets

### **BIOS**

AMI EFI with CMOS backup in 16 Mb SPI flash

### Hardware Monitor

Supply voltages and CPU temperature Debug Interface XDP SFF-26 extension for ICE debug

### **Watchdog Timer**

Programmable timer range to generate RESET

### **Expansion Busses**

PCI Express x16 (Gen2) bus for discrete graphics solution or general purpose PCI Express (2 x8 or 1 x8 with 2 x4) 8 PCI Express x1: Lanes 0/1/2/3/4/5/6 are free, lane 7 is occupied by GbE LPC bus, SMBus (system), I2C (user)

### Multi I/O and Storage

Chipset: Integrated on QM67
USB: Supports up to eight ports USB 2.0
SATA: Two SATA 6 Gb/s, two SATA 3 Gb/s with support for RAID 0,1,5,10

#### Video

### Integrated in Processor

HD Graphics 3000 at 650-1300 MHz

### Integrated Video

DirectX 10.1 and OpenGL 3.0

### Feature Support

Intel® Clear Video HD Technology Advanced Scheduler 2.0, 1.0, XPDM support DirectX Video Acceleration (DXVA) support for full AVC/VC1/MPEG2 hardware decode

### VGA

Analog VGA support with 300 MHz DAC Analog monitor support up to QXGA (2048 x 1536) and VGA hot plug

### **LVDS**

Dual channel 18/24-bit LVDS

### Digital Display Interface

Three DDI ports supporting HDMI / DVI / DisplayPort or SDVO

### Ethernet

Chipset: Intel® Gigabit LAN PHY WG82579LM Speed: 10/100/1000 Mbps Ethernet

### Super I/O

Connected to LPC bus on carrier if needed

### TPM

Chipset: Atmel AT97SC3204 Type: TPM 1.2

### Power

Input Power: AT mode (12 V +/- 5%) and ATX mode (12 V and 5 Vsb +/- 5%) Power States: Supports S0, S1, S3, S4, S5 Power Consumption: TBD Smart Battery Support: Yes



### **Specifications**

• Mechanical and Environmental

Size: COM Express Basic, 125 mm x 95 mm Board Thickness: 0.093" (2.3mm)

**Operating Temperature** 

Standard: 0°C to 60°C

Extended: -40°C to 85°C (build option, and not available for Core  $^{\rm m}$  i7-2715QE) Storage Temperature : -55°C to 85°C

Humidity

90% at 60°C non-condensing

Shock

50G peak-to-peak, 11ms duration, MIL-STD-202G Method 213B

Vibration

Operating: 11.96 Grms, 50-20,000 Hz, each axis, MIL-STD-202G Method 214A Compatibility: PICMG COM Express COM.0 R2.1 Type 6

Certifications: CE, FCC, HALT

Operating Systems

Standard Support
Windows 7, Linux

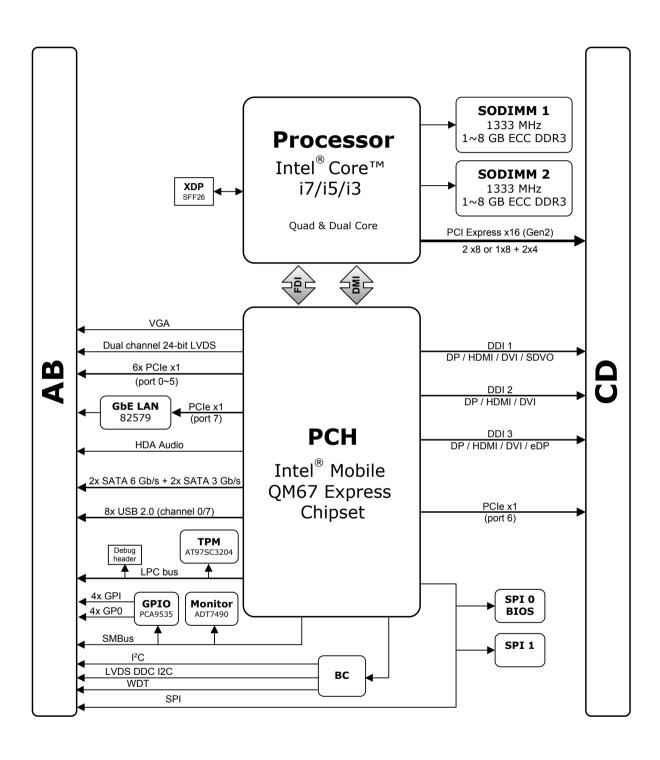
Extended Support (BSP)

Windows XPe/7, WEC 7, Linux, VxWorks 6.9, QNX 6.5, AIDI Library

Note: "Build option" indicates an alternative BOM configuration to support additional or alternative functions that are not available on the standard product. Be aware that part numbers for SKUs with "build options" will need to be created and may cause production lead times.



### **Functional Diagram**



### **Ordering Information**

### • Express-HRR-i7-R-2715QE

Extreme Rugged COM Express Type 6 module with Intel® Core™ i7-2715QE Quad Core processor 2.1GHz 45W with QM67 chipset (Ext. Temp. not available)

### • Express-HRR-i7-R-2655LE

Extreme Rugged COM Express Type 6 module with Intel® Core™ i7-2655LE Dual Core processor 2.2GHz 25W with OM67 chipset

### • Express-HRR-i7-R-2610UE

Extreme Rugged COM Express Type 6 module with Intel® Core™ i7-2610UE Dual Core processor 1.5GHz 17W with QM67 chipset

### Express-HRR-i5-2515E

Extreme Rugged COM Express Type 6 module with Intel® Core™ i5-2515E Dual Core processor 2.5GHz 35W with QM67 chipset

### Express-HRR-i3-R-2340UE

Extreme Rugged COM Express Type 6 module with Intel® Core™ i3-2340UE ULV Dual Core processor 1.3GHz 17W with QM67 chipset

### Express-HRR-R-847E

Extreme Rugged COM Express Type 6 module with Intel® Celeron® 847E LV Dual Core processor 1.1GHz 17W with QM67 chipset

### • Express-HRR-R-807UE

Extreme Rugged COM Express Type 6 module with Intel® Celeron® 807UE ULV Single Core processor 1.0GHz 10W with QM67 chipset

### **Accessories**

### **Heat Spreaders**

#### HTS-HRR-BTF

Heatspreader for Express-HRR with through hole standoffs for top mounting

#### **Passive Heatsinks**

### THSH-HRR-BTL

Heatsink for Express-HRR with through hole standoffs for top mounting  $% \left\{ \mathbf{r}_{1}^{H}\right\} =\mathbf{r}_{2}^{H}$ 

### **Active Heatsink**

### THSF-HRR-BTL-CU

Heatsink with FAN for Express-HRR with through hole standoffs for top mounting

### Starter Kit

### COM Express Type 6 Starter Kit Plus

COM Express formfactor starter kit with Express-BASE6 board, power supply, and accessory kit



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Express-HRR-i7-L-2610UE Express-HRR-i7-R-2715QE